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APPLICATION N	O. F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/718,897	18,897 11/20/2003		Shao-Chung Hu	JCLA11797	1661	
23900	7590	08/31/2005		EXAMINER		
	ENTS, INC		ROSE, KIESHA L			
	RE, SUITE CA 92618			ART UNIT PAPER NUMBER 2822		
,						
			DATE MAILED, 00/21/2005			

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
	10/718,897	HU ET AL.	an				
Office Action Summary	Examiner	Art Unit					
	Kiesha L. Rose	2822					
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with th	e correspondence add	dress				
A SHORTENED STATUTORY PERIOD FOR REPL' THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl' If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply by within the statutory minimum of thirty (30) will apply and will expire SIX (6) MONTHS to become ABANDO	e timely filed days will be considered timely. from the mailing date of this condition (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on 21 Ju	<u>une 2005</u> .						
2a)⊠ This action is FINAL . 2b)□ This	action is non-final.						
3) Since this application is in condition for alloward closed in accordance with the practice under E	•	•	merits is				
Disposition of Claims							
4) ☐ Claim(s) 15-23 is/are pending in the application 4a) Of the above claim(s) is/are withdray 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 15-23 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	wn from consideration.						
Application Papers							
9) The specification is objected to by the Examine	er.						
10) The drawing(s) filed on is/are: a) acc	☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.						
Applicant may not request that any objection to the	drawing(s) be held in abeyance.	See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correct	,	<u>-</u>	• •				
11) The oath or declaration is objected to by the Ex	caminer. Note the attached Off	ice Action or form PT	O-152.				
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Applic rity documents have been rece u (PCT Rule 17.2(a)).	cation No eived in this National S	Stage				
Attachment(s)		•					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)	4) Interview Summ Paper No(s)/Ma 5) Notice of Inform 6) Other:		-152)				
Paper No(s)/Mail Date			•				

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DETAILED ACTION

This Office Action is in response to the amendment filed 21 June 2005.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 15-17 and 21 are rejected under 35 U.S.C. 102(e) as being anticipated by Morrow et al (U.S. Publication 2004/0058547).

Morrow discloses an integrated circuit interconnect (Figs. 2I, 2O and 2Q) that contains a first dielectric layer (210) having a first opening therein, a first metal layer (224) formed in the first opening and comprising copper, a first protective layer (230) formed on the surface of the first metal layer not covered by the first dielectric layer, a first stop layer (234) on the surface of the first dielectric layer with the opening formed in the first dielectric layer and the first stop layer, a second dielectric layer (236) formed over the first dielectric layer, a second metal layer (252) filled in the second opening comprising copper, a second protective layer formed on the surface of the second metal layer not covered by the second dielectric layer and a second stop layer on the surface

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of the second dielectric layer wherein the opening is formed in the second dielectric layer and the second stop layer, wherein the first protective layer and second protective layer are formed from a mixture of the first and second metal layer and a first and second film layer (226/232) that is conductive or non-conductive and where the first film layer is reactive with the first and second metal layers but non-reactive with the first and second dielectric layers. (Figs. 2h-2j, Page 3, Paragraph 25)

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 18-20 and 22-23 are rejected under 35 U.S.C. 103(a) as being unpatentable over Morrow in view of Maiz (U.S. Patent 6,794,755).

Morrow discloses all the limitations except for the second dielectric layer having a second opening cutting through the first protective layer. Whereas Maiz discloses an integrated circuit interconnect (Fig 2G) that contains a first dielectric layer (210) having a first opening therein, a first metal layer (224) formed in the first opening and comprising copper, a first protective layer (218) formed on the surface of the first metal layer not covered by the first dielectric layer, a first stop layer (244) on the surface of the first dielectric layer with the opening formed in the first dielectric layer and the first stop layer, a second dielectric layer (246) formed over the first dielectric layer with a second

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opening cutting through the first protective layer to expose the first metal layer, a second metal layer (280) filled in the second opening comprising copper, a second protective layer formed on the surface of the second metal layer not covered by the second dielectric layer and a second stop layer on the surface of the second dielectric layer wherein the opening is formed in the second dielectric layer and the second stop layer. (Damascene formed has more than one interconnect level and can be repeated. (Column 7, lines 53-55) The second dielectric layer has a second opening cutting through the first protective layer to provide electrical connection between the first interconnect and the second interconnect. (Column 10, lines 10) Therefore it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the device of Morrow by incorporating the second dielectric to have a second opening to cut through the first protective layer to provide electrical connection between the first interconnect and the second interconnect as taught by Maiz.

Response to Arguments

Applicant's arguments with respect to claims 15-23 have been considered but are moot in view of the new ground(s) of rejection. In regards to the new limitation the first and second protective layer mixed with the first and second metal layers and a first and second film layer, where the film layers react with the metal layers but does not react with the dielectric layer, this limitation is shown in Figs. 2h-2j and shows that the protective layer is only formed over the metal layers.

Conclusion

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kiesha L. Rose whose telephone number is 571-272-1844. The examiner can normally be reached on M-F 8:30-6:00 off 2nd Mondays.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Amir Zarabian can be reached on 571-272-1852. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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EXAMINER

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